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**Fiksni upori za uporabo v elektronski opremi - 4-20. del: Neizpolnjena podrobna specifikacija - Močnostni upori z aksialnimi priključki za montažo skozi prehodne luknje tiskanih vezij (THT) za visokozmogljivo elektronsko opremo, razvrstitvena raven P, ali za visokozmogljivo in zelo zanesljivo elektronsko opremo, razvrstitvena raven G**

Fixed resistors for use in electronic equipment - Part 4-20: Blank detail specification: Power resistors with axial leads for through-hole assembly on circuit boards (THT), for high performance electronic equipment, classification level P, or for high-performance high-reliable electronic equipment, classification level R

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Résistances fixes utilisées dans les équipements électroniques - Partie 4-20: Spécification particulière-cadre: Résistances de puissance à broches axiales pour assemblage par trous traversants sur cartes de circuit imprimé (THT), pour les équipements électroniques de haute performance (niveau de classification P), ou pour les équipements électroniques de haute performance et de haute fiabilité (niveau de classification R)

**Ta slovenski standard je istoveten z: prEN IEC 60115-4-20:2025**

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**ICS:**

31.040.10	Fiksni upor	Fixed resistors
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**oSIST prEN IEC 60115-4-20:2026**      **en**





# 40/3265/CDV

## COMMITTEE DRAFT FOR VOTE (CDV)

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SECRETARIAT: Netherlands	SECRETARY: Mr Ronald Drenthen
OF INTEREST TO THE FOLLOWING COMMITTEES:	HORIZONTAL FUNCTION(S):
ASPECTS CONCERNED:	
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TITLE:

**Fixed resistors for use in electronic equipment - Part 4-20: Blank detail specification: Power resistors with axial leads for through-hole assembly on circuit boards (THT), for high performance electronic equipment, classification level P, or for high-performance high-reliable electronic equipment, classification level R**

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**FIXED RESISTORS FOR USE IN ELECTRONIC EQUIPMENT –**

**Part 4-20: Blank detail specification:  
Power resistors with axial leads  
for through-hole assembly on circuit boards (THT),  
for high-performance electronic equipment, classification level P,  
or for high-performance and high-reliable electronic equipment,  
classification level R**

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This edition includes the following significant technical changes with respect to the high performance and high reliable previous edition:

- a) it employs the product classification based on application requirements as defined in the generic specification IEC 60115-1:2020;
- b) it permits the specification additional dimensional requirements concerning the eccentricity of termination wires and the coating extending onto wires;